

MOSFET

OptiMOS[™] 5 Power-Transistor, 150 V

Features

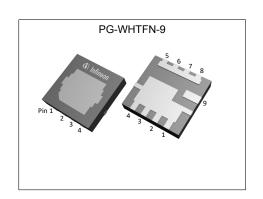
- N-channel, normal level
- Superior thermal resistance
- 100% avalanche tested
- Pb-free lead plating; RoHS compliant
 Halogen-free according to IEC61249-2-21
- Optimized for high performance SMPS, e.g. synchronous rectification

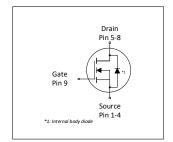
Product validation

Fully qualified according to JEDEC for Industrial Applications

Table 1 **Key Performance Parameters**

Parameter	Value	Unit
V _{DS}	150	V
$R_{ extsf{DS(on),max}}$	22	mΩ
I _D	44	A
Qoss	40	nC
Q _G	14.4	nC











Type / Ordering Code	Package	Marking	Related Links
IQE220N15NM5CGSC	PG-WHTFN-9	Т	-

OptiMOS[™] 5 Power-Transistor, 150 V IQE220N15NM5CGSC



Rev. 2.0, 2023-03-21

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OptiMOS[™] 5 Power-Transistor, 150 V IQE220N15NM5CGSC



1 Maximum ratings at T_A =25 °C, unless otherwise specified

Table 2 Maximum ratings

Danamatan	0 b a l		Value	s			
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition	
Continuous drain current ¹⁾	I _D	- - -	-	44 31 7	A	V_{GS} =10 V, T_{C} =25 °C V_{GS} =10 V, T_{C} =100 °C V_{GS} =10 V, T_{A} =25 °C, R_{thJA} =60 °C/W ²⁾	
Pulsed drain current ³⁾	I _{D,pulse}	-	-	176	Α	<i>T</i> _C =25 °C	
Avalanche energy, single pulse ⁴⁾	E AS	-	-	40	mJ	$I_{\rm D}$ =20 A, $R_{\rm GS}$ =25 Ω	
Gate source voltage	V _{GS}	-20	-	20	V	-	
Power dissipation	P _{tot}	-	-	100 2.5	W	T _C =25 °C T _A =25 °C, R _{thJA} =60 °C/W ²⁾	
Operating and storage temperature	$T_{\rm j},~T_{\rm stg}$	-55	-	175	°C	-	

Thermal characteristics 2

Table 3 Thermal characteristics

Parameter	Symbol	Values			Unit	Note / Test Condition
Farameter	Symbol	Min.	Тур.	Max.	Ullit	Note / Test Condition
Thermal resistance, junction - case, bottom	R _{thJC}	-	0.8	1.5	°C/W	-
Thermal resistance, junction - case, top	R _{thJC}	-	0.7	-	°C/W	-
Thermal resistance, junction - ambient, 6 cm² cooling area²)	R _{thJA}	-	-	60	°C/W	-

¹⁾ Rating refers to the product only with datasheet specified absolute maximum values, maintaining case temperature as specified. For other case temperatures please refer to Diagram 2. De-rating will be required based on the actual environmental conditions. $^{2)}$ Device on 40 mm x 1.5 mm epoxy PCB FR4 with 6 cm 2 (one layer, 70 μ m thick) copper area for drain

connection. PCB is vertical in still air.

3) See Diagram 3 for more detailed information

⁴⁾ See Diagram 13 for more detailed information

OptiMOS[™] 5 Power-Transistor, 150 V IQE220N15NM5CGSC



Electrical characteristics

at T_j=25 °C, unless otherwise specified

Static characteristics Table 4

D	0		Values			
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Drain-source breakdown voltage	V _{(BR)DSS}	150	-	-	V	V _{GS} =0 V, I _D =1 mA
Gate threshold voltage	V _{GS(th)}	3.0	3.8	4.6	V	V _{DS} =V _{GS} , I _D =46 μA
Zero gate voltage drain current	I _{DSS}	-	0.1 10	1 100	μΑ	V _{DS} =120 V, V _{GS} =0 V, T _j =25 °C V _{DS} =120 V, V _{GS} =0 V, T _j =125 °C
Gate-source leakage current	I _{GSS}	-	10	100	nA	V _{GS} =20 V, V _{DS} =0 V
Drain-source on-state resistance	R _{DS(on)}	-	17.4 19.4	22 35	mΩ	V _{GS} =10 V, I _D =26 A V _{GS} =8 V, I _D =20 A
Gate resistance ¹⁾	R _G	-	0.8	1.2	Ω	-
Transconductance	g fs	-	32	-	S	$ V_{DS} \ge 2 I_D R_{DS(on)max}, I_D = 22 A$

Table 5 **Dynamic characteristics**

Devementar	Crossball	Values			11	Nata / Tant Candition
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Input capacitance ¹⁾	Ciss	-	1100	1400	pF	V _{GS} =0 V, V _{DS} =75 V, <i>f</i> =1 MHz
Output capacitance ¹⁾	Coss	-	270	350	pF	V _{GS} =0 V, V _{DS} =75 V, <i>f</i> =1 MHz
Reverse transfer capacitance ¹⁾	C _{rss}	-	8	14	pF	V _{GS} =0 V, V _{DS} =75 V, <i>f</i> =1 MHz
Turn-on delay time	$t_{\sf d(on)}$	-	8	-	ns	$V_{\rm DD}$ =75 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =22 A, $R_{\rm G,ext}$ =1.6 Ω
Rise time	t _r	-	2	-	ns	$V_{\rm DD}$ =75 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =22 A, $R_{\rm G,ext}$ =1.6 Ω
Turn-off delay time	$t_{\sf d(off)}$	-	8	-	ns	$V_{\rm DD}$ =75 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =22 A, $R_{\rm G,ext}$ =1.6 Ω
Fall time	t _f	-	2	-	ns	$V_{\rm DD}$ =75 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =22 A, $R_{\rm G,ext}$ =1.6 Ω

Gate charge characteristics²⁾ Table 6

Parameter	Symbol	Values			l lmi4	Note / Test Condition
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Gate to source charge	Q gs	-	6.2	-	nC	$V_{\rm DD}$ =75 V, $I_{\rm D}$ =22 A, $V_{\rm GS}$ =0 to 10 V
Gate charge at threshold	$Q_{g(th)}$	-	4.0	-	nC	$V_{\rm DD}$ =75 V, $I_{\rm D}$ =22 A, $V_{\rm GS}$ =0 to 10 V
Gate to drain charge ¹⁾	Q_{gd}	-	3.1	4.7	nC	$V_{\rm DD}$ =75 V, $I_{\rm D}$ =22 A, $V_{\rm GS}$ =0 to 10 V
Switching charge	Q _{sw}	-	5.3	-	nC	$V_{\rm DD}$ =75 V, $I_{\rm D}$ =22 A, $V_{\rm GS}$ =0 to 10 V
Gate charge total ¹⁾	Qg	-	14.4	18	nC	$V_{\rm DD}$ =75 V, $I_{\rm D}$ =22 A, $V_{\rm GS}$ =0 to 10 V
Gate plateau voltage	V _{plateau}	-	5.8	-	V	$V_{\rm DD}$ =75 V, $I_{\rm D}$ =22 A, $V_{\rm GS}$ =0 to 10 V
Gate charge total, sync. FET	Q _{g(sync)}	-	12.2	-	nC	V _{DS} =0.1 V, V _{GS} =0 to 10 V
Output charge ¹⁾	Qoss	-	40	53	nC	V _{DS} =75 V, V _{GS} =0 V

 $^{^{1)}}$ Defined by design. Not subject to production test. $^{2)}$ See "Gate charge waveforms" for parameter definition

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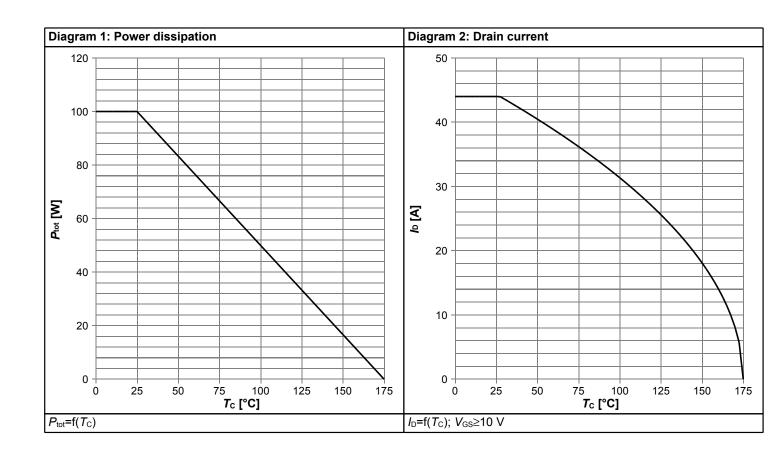


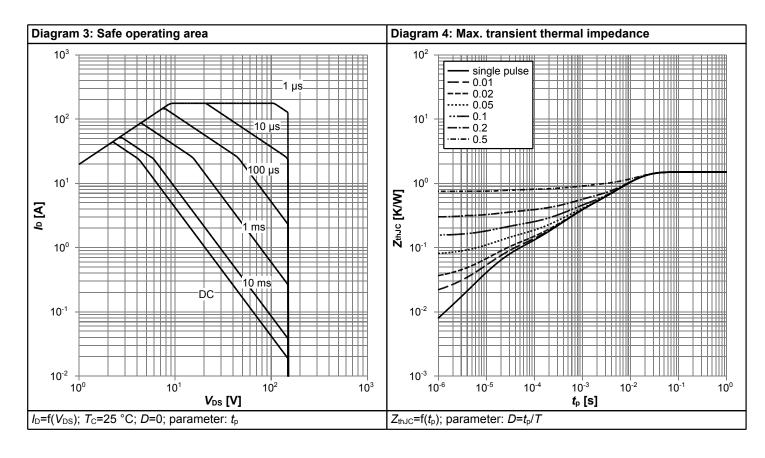
Table 7 Reverse diode

Davomotor	Symbol		Values			Note / Took Condition	
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition	
Diode continuous forward current	Is	-	-	44	Α	<i>T</i> _C =25 °C	
Diode pulse current	I _{S,pulse}	-	-	176	Α	<i>T</i> _C =25 °C	
Diode forward voltage	V _{SD}	-	0.86	1.2	V	V _{GS} =0 V, I _F =22 A, T _j =25 °C	
Reverse recovery time ¹⁾	t _{rr}	-	25	50	ns	V _R =75 V, I _F =22 A, di _F /dt=100 A/μs	
Reverse recovery charge ¹⁾	Qrr	-	17	34	nC	V_R =75 V, I_F =22 A, di_F/dt =100 A/ μ s	

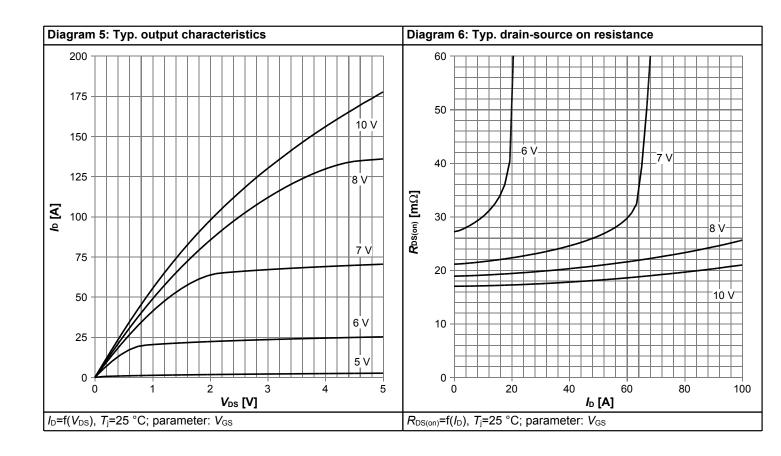


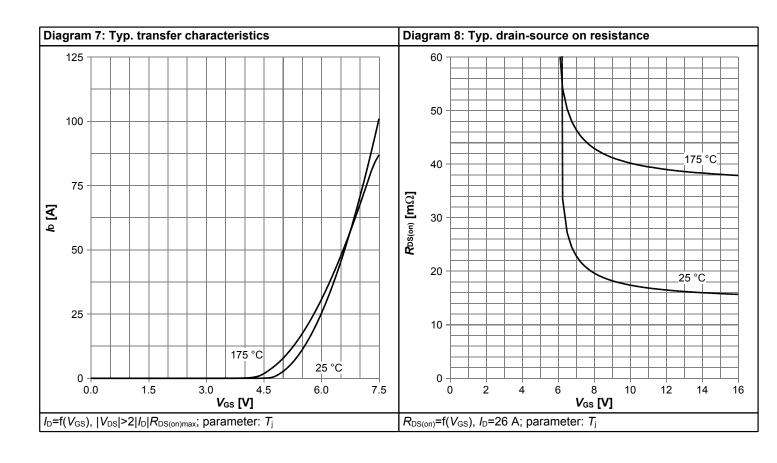
4 Electrical characteristics diagrams



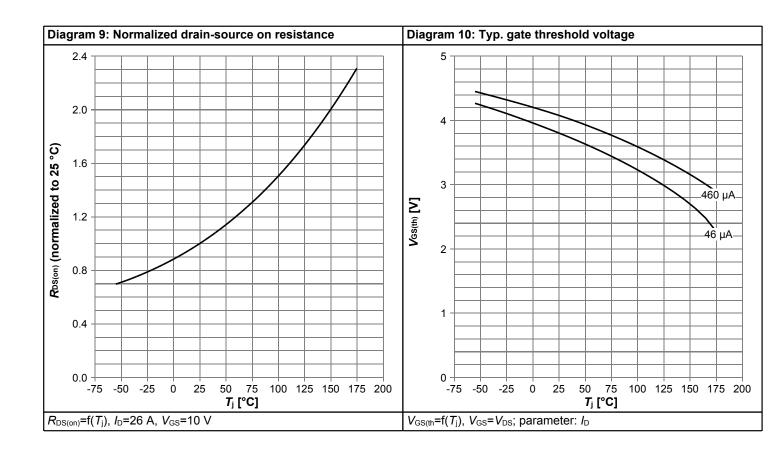


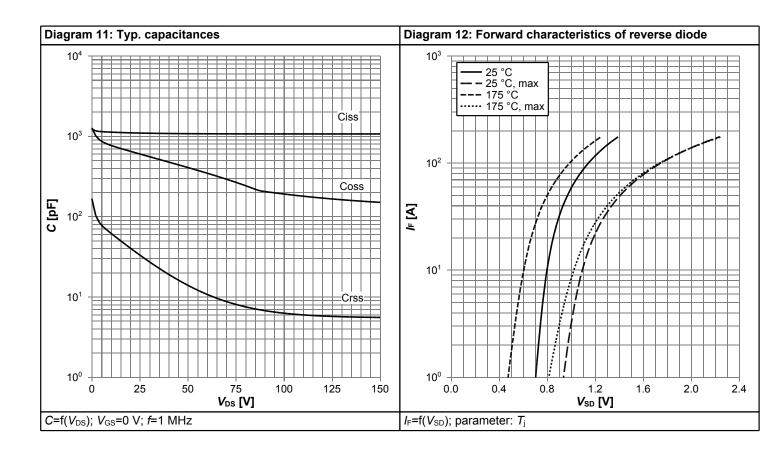




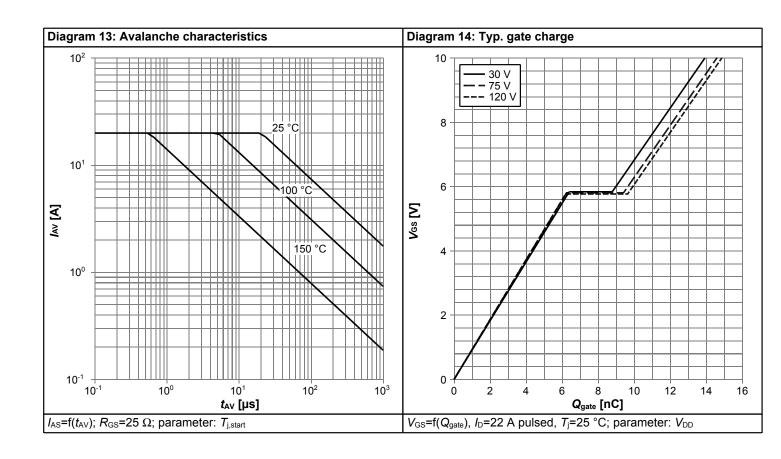


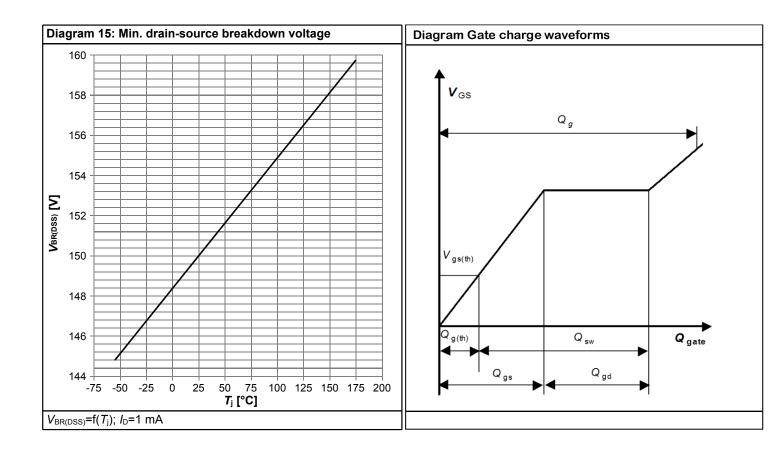














5 Package Outlines

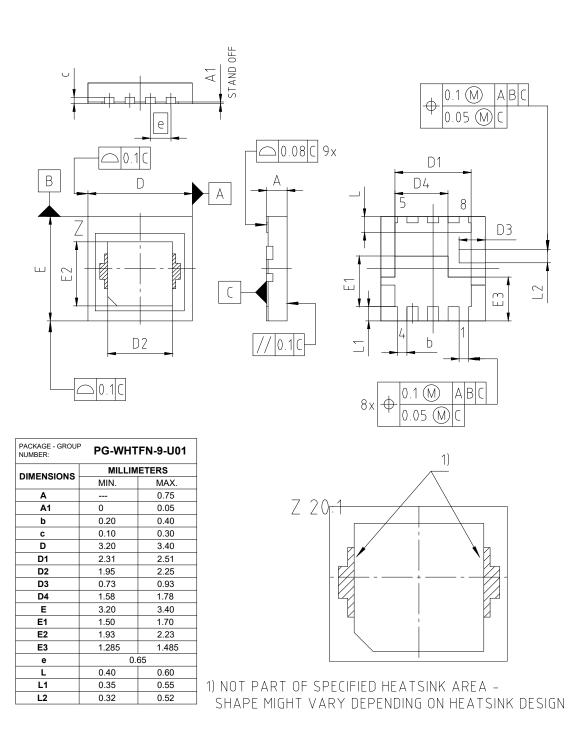


Figure 1 Outline PG-WHTFN-9, dimensions in mm

OptiMOSTM 5 Power-Transistor, 150 V



Revision History

IQE220N15NM5CGSC

Revision: 2023-03-21, Rev. 2.0

Previous Revision

Revision	Date	Subjects (major changes since last revision)
2.0	2023-03-21	Release of final version

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